September 2000



FDS8433A Single P-Channel 2.5V Specified MOSFET

General Description

This P-Channel enhancement mode power field effect transistors is produced using Fairchild's proprietary, high cell density, DMOS technology. This very high density processis especially tailored to minimize on-state resistance and provide superior switching performance.

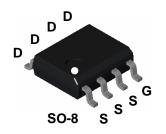
Applications

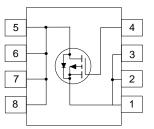
- Load switch
- DC/DC converter
- Battery protection

Features

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• -5 A, -20 V. R_{DS(on)} = 0.047 \ \Omega \ @ V_{GS} = -4.5 \ V
R_{DS(on)} = 0.070 \ \Omega \ @ V_{GS} = -2.5 \ V
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- Fast switching speed.
- High density cell design for extremely low R_{DS(on)}.
- High power and current handling capability.





Absolute Maximum Ratings T_A = 25°C unless otherwise noted

Symbol	Parameter		FDS8433A	Units
V _{DSS}	Drain-Source Voltage		-20	V
V _{GSS}	Gate-Source Voltage		<u>±</u> 8	V
ID	Drain Current - Continuous	(Note 1a)	-5	A
	- Pulsed		-50	
P _D	Power Dissipation for Single Operation	(Note 1a)	2.5	W
		(Note 1b)	1.2	
		(Note 1c)	1	
T _J , T _{stg}	Operating and Storage Junction Temperature Range		-55 to +150	°C

Thermal Characteristics

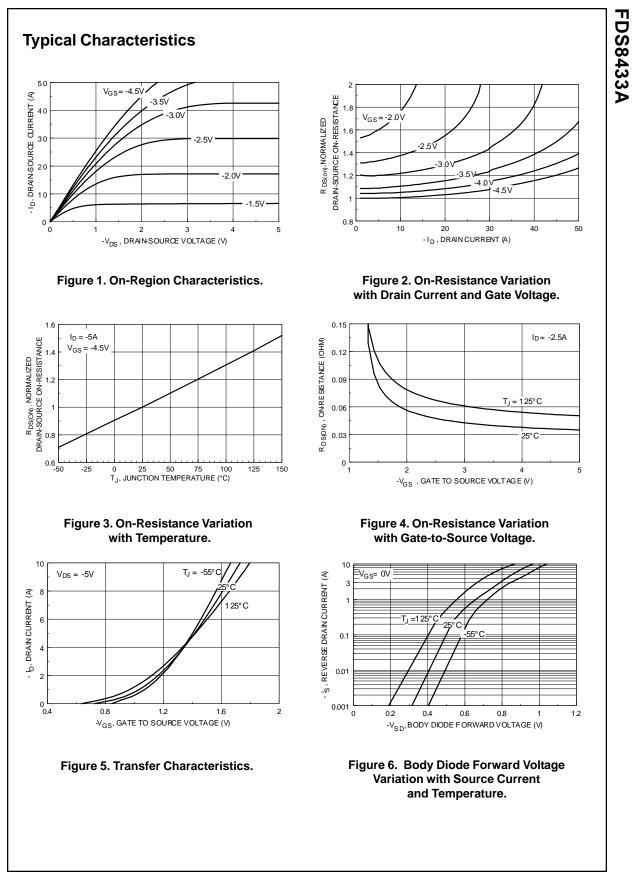
R _{ØJA}	Thermal Resistance, Junction-to-Ambient	(Note 1a)	50	∘C/W
$R_{\theta^{JC}}$	Thermal Resistance, Junction-to-Case	(Note 1)	25	°C/W

Package Outlines and Ordering InformationDevice MarkingDeviceReel SizeTape WidthQuantityFDS8433AFDS8433A13"12mm2500 units

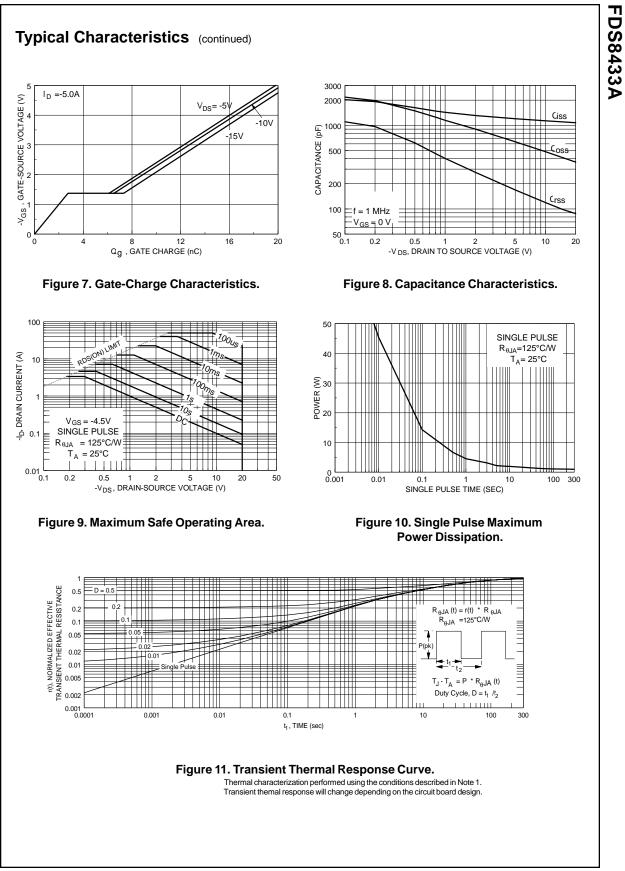
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Off Chara	Parameter	Test Conditions	Min	Тур	Max	Units
	acteristics					
.033	Drain-Source Breakdown Voltage	$V_{GS} = 0 V, I_{D} = -250 \mu A$	-20			V
BVDSS ΔT.I	Breakdown Voltage Temperature Coefficient	I_D = -250 μ A, Referenced to 25°C		-25		mV/°C
DSS	Zero Gate Voltage Drain Current	$V_{DS} = -16 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$			-1	μA
GSSF	Gate-Body Leakage Current, Forward	$V_{GS} = 8 V, V_{DS} = 0 V$			100	nA
GSSR	Gate-Body Leakage Current, Reverse	V_{GS} = -8 V, V_{DS} = 0 V			-100	nA
On Chara	acteristics (Note 2)				-	
V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_{D} = -250 \ \mu A$	-0.4	-0.6	-1	V
Δ _{VGS(th)} Δ _{T,1}	Gate Threshold Voltage Temperature Coefficient	$I_D = -250 \ \mu A$, Referenced to $25^{\circ}C$		4		mV/°C
R _{DS(on)}	Static Drain-Source	$V_{GS} = -4.5 \text{ V}, I_D = -5 \text{ A}$		0.036	0.047	Ω
	On-Resistance	$V_{GS} = -4.5 \text{ V}, I_D = -5 \text{ A}, T_J = 125^{\circ}\text{C}$		0.050	0.085	Ω
	On-State Drain Current	$V_{GS} = -2.5 \text{ V}, I_D = -4.3 \text{ A}$ $V_{GS} = -4.5 \text{ V}, V_{DS} = -5 \text{ V}$	-25	0.047	0.070	Ω Α
I _{D(on)} g _{FS}	Forward Transconductance	$V_{DS} = -5 V, I_D = -5 A$	20	16		S
						•
Dynamic C _{iss}	Characteristics	$V_{DS} = -10 \text{ V}, \text{ V}_{GS} = 0 \text{ V},$		1130		pF
Coss	Output Capacitance	f = 1.0 MHz		480		pF
Crss	Reverse Transfer Capacitance			120		pF
Switchin t _{d(on)}	g Characteristics (Note 2) Turn-On Delay Time	V _{DD} = -10 V, I _D = -1 A,		8	16	ns
t _r	Turn-On Rise Time	$V_{GS} = -4.5 \text{ V}, \text{ R}_{GEN} = 6 \Omega$		23	37	ns
t _{d(off)}	Turn-Off Delay Time	-		260	360	ns
t _f	Turn-Off Fall Time			90	125	ns
Qg	Total Gate Charge	$V_{DS} = -5 V, I_{D} = -5 A,$		20	28	nC
Q _{gs}	Gate-Source Charge	$V_{GS} = -5 V$,		2.8		nC
Q _{gd}	Gate-Drain Charge			3.2		nC
		d Movimum Potingo				
s s	urce Diode Characteristics an Maximum Continuous Drain-Source Dio				-2.1	А
V _{SD}	Drain-Source Diode Forward Voltage	$V_{GS} = 0 V, I_S = -2.1 A$ (Note 2)		-0.8	-1.2	V

FDS8433A



FDS8433A Rev. C



FDS8433A Rev. C

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